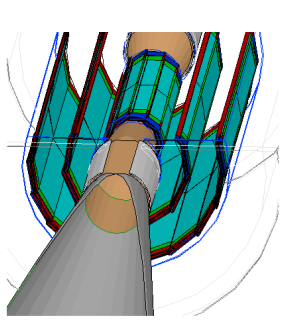


# ILD vertex detector: VXD Integration

ILD inner region integration meeting, LAL, 2010 June 30

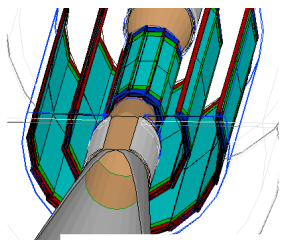
J.Baudot, for the IPHC group  
baudot@in2p3.fr

- x Overview
- x Mechanics
- x Cooling
- x Cabling
- x Material budget



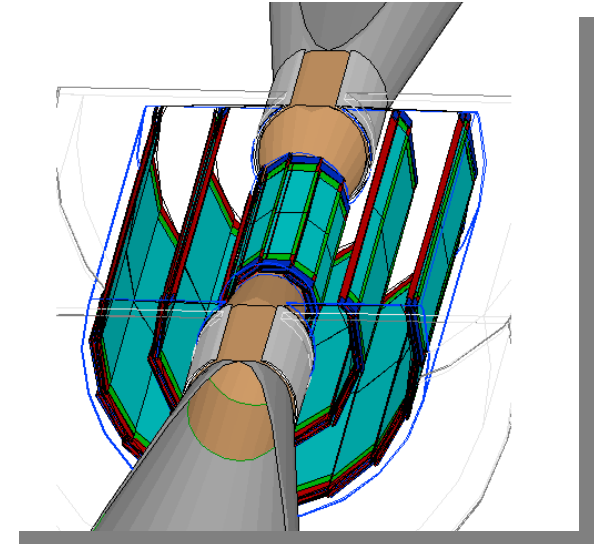
- 
- **Overview**
  - Mechanics
  - Cooling
  - Cabling
  - Material budget
-

# Two options for geometry



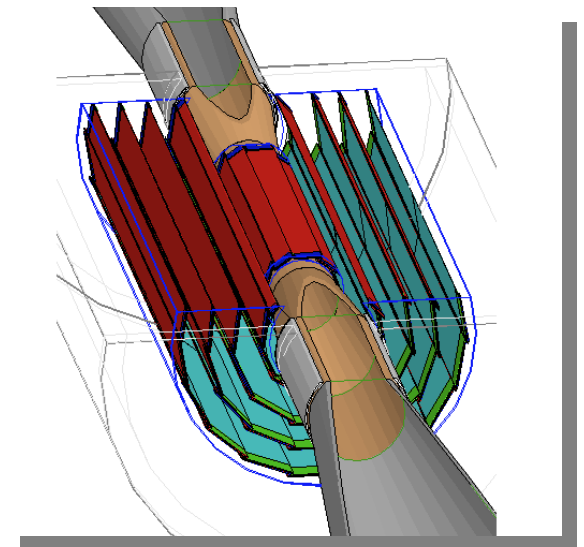
## ● Double sided ladder

- x Ladder is equipped with two layers of sensors
  - Material budget (LOI target) 0.16% X0
- x 3 ladders

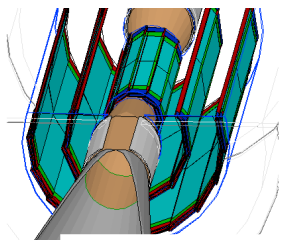


## ● Single sided ladder

- x Ladder is equipped with one layer of sensor
  - Material budget (LOI target) 0.11% X0
- x 5 ladders



# Sensor options



## ● CMOS pixel sensors

- x Power dissipation  $\sim 100\text{mW}/\text{cm}^2$ 
  - Full detector  $\sim 1\text{ KW}$  while active
  - Factor 1/50(100) for average
- x Servicing required
  - ?
- x

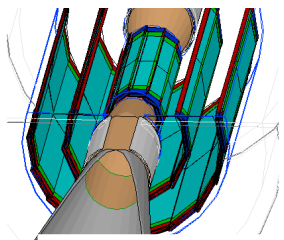
## ● CCDs

- x FinePixelCCD, ISIS
- x CCD to be kept at low temp  
Power dissipation ?  $\text{mW}/\text{cm}^2$
- x Servicing required

## ● DEPFET sensors

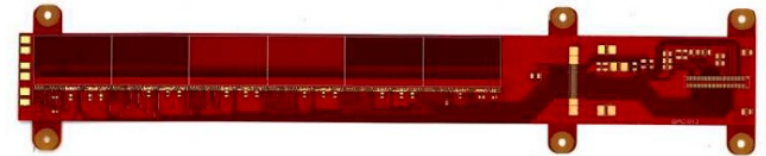
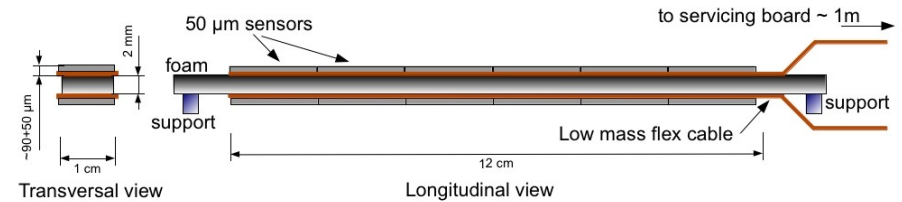
- x Power dissipation ?  $\text{mW}/\text{cm}^2$
- x Servicing required

# Ladder prototype



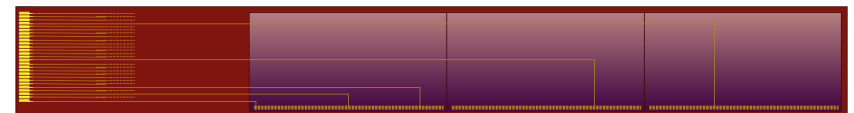
## ● PLUME project

- x Bristol U. DESY, IPHC, Oxford U.
- x Running from 2009 to 2012
- x Double sided ladder with 0.3% X0 goal
- x Focus on CMOS sensors  
BUT should accommodate other technologies

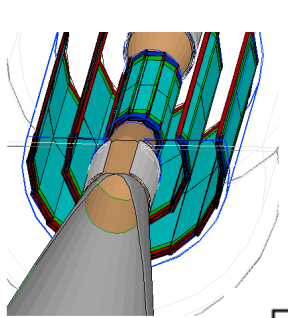


## ● SERWIETE project

- x IPHC, IKFrankfurt, IMEC Leuven
  - EU-FP7, Hadron Physics 2 project
- x Embedding the sensor inside kapton & metal layers
  - Benefit from ultimate CMOS thickness (20-30μm)
  - Allow very thin metal traces down to 1μm
  - Material budget for 1 module  $O(0.1) \% X0$

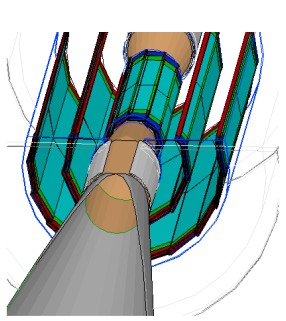


# Numbers



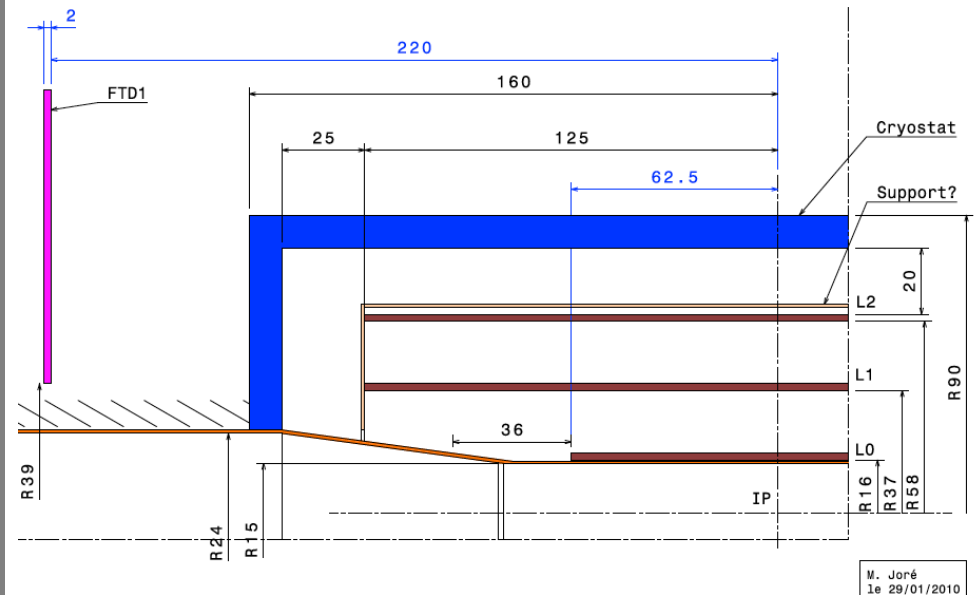
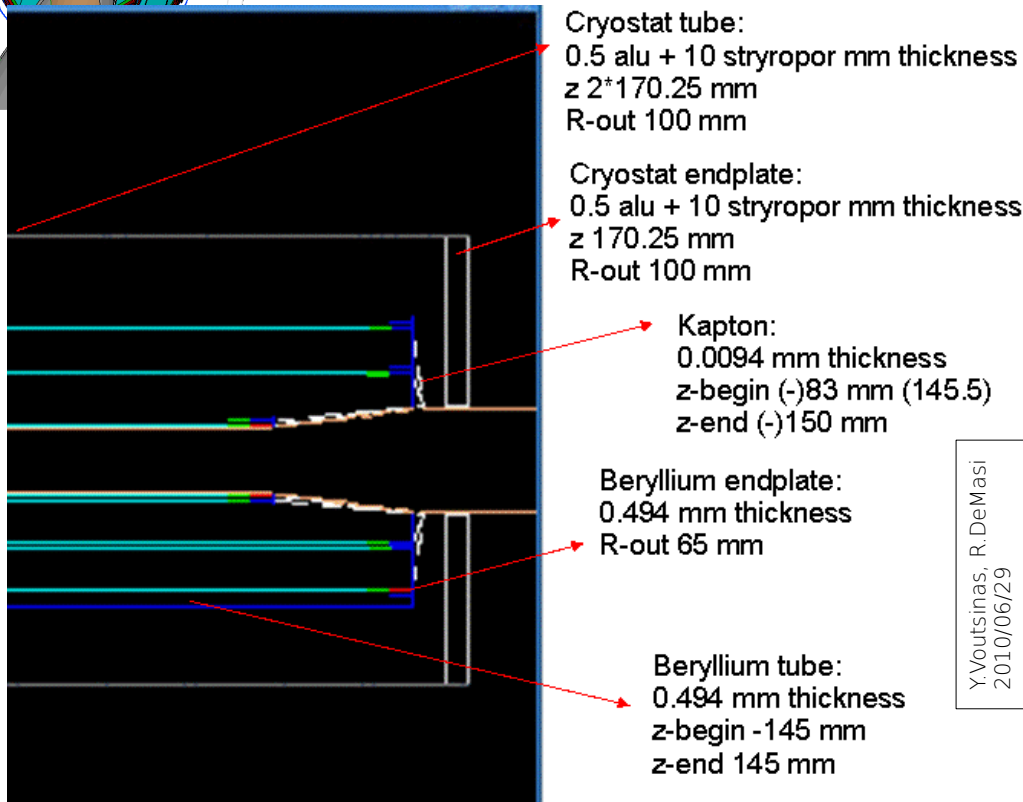
geometry	radius [mm]		ladder length [mm]		read-out time [ $\mu s$ ]	
	VTX-SL	VTX-DL	VTX-SL	VTX-DL	VTX-SL	VTX-DL
layer 1	15.0	16.0/18.0	125.0	125.0	25-50	25-50
layer 2	26.0	37.0/39.0	250.0	250.0	50-100	100-200
layer 3	37.0	58.0/60.0	250.0	250.0	100-200	100-200
layer 4	48.0		250.0		100-200	
layer 5	60.0		250.0		100-200	

- x ~100 ladders in total
- x 300-500 Mpixels



- 
- Overview
  - **Mechanics**
  - Cooling
  - Cabling
  - Material budget
-

# Mokka vs Mecha. model



## Mokka (VXD03)

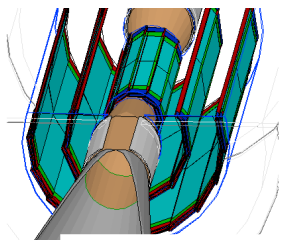
- x Simplistic double-sided ladder  
= 2xsingle-sided ladder  
BUT radiation length match LOI target
- x Cryostat larger R(+10mm) & z (+10mm)  
/ mecha. model

## Mechanical model

- x Miss ladder fixtures on support  
→ Support z is -20mm / Mokka
- x Miss kapton cables from ladders to pipe
- x Support radius lower (-5mm) / Mokka



# Supporting the VXD



## ● Layer support

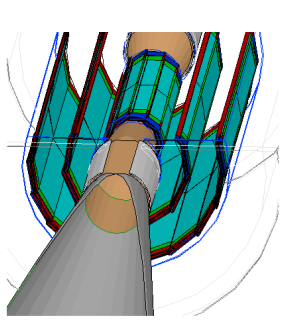
- x 1<sup>st</sup> layer is mounted on the beam pipe
- x 2<sup>nd</sup> & 3<sup>rd</sup> layers mounted on the Beryllium support
- x Beryllium support clamped on beam pipe
- x No study on the impact of beam pipe deformation
- x No technical drawing available (manpower)

## ● Mechanical alignment

- x Initial survey ( $<100\mu\text{m}$ ) should be good enough
- x Note: IR light go through CMOS sensors (both sides)

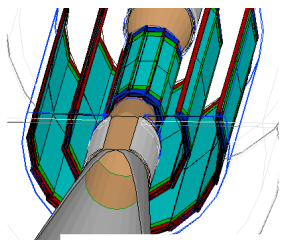
## ● Mounting concept

- x No detail work done



- 
- Overview
  - Mechanics
  - **Cooling**
  - Cabling
  - Material budget
-

# Two options

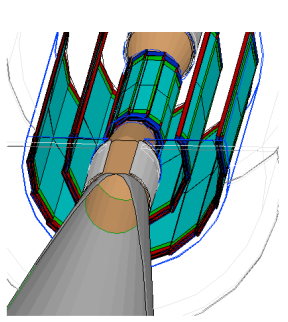


## ● Room temperature operation

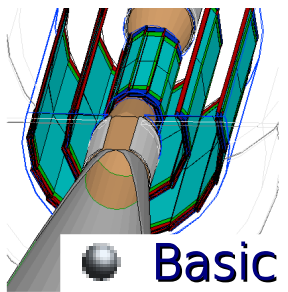
- x CMOS-like sensors
- x Passive cooling
  - Air flow  $\sim 1$  m/s (for mech. Stability)
  - Sensor Temp  $\sim 10$ - $30$  °C
  - Air Temp. Under study
- x No real cryostat, nevertheless
  - Faraday cage needed
  - May require air separation / SIT
  - Some thickness of aluminium
- x Tubes required on beam pipe
  - Diameter ? mm

## ● Negative temperature operation

- x FinePixel-CCD-like sensors
- x Active cooling required
  - CO<sub>2</sub> evaporation in tubes
  - Sensor Temp  $\sim -(5$ - $15)$  °C
- x Real cryostat needed
  - Backbone 0.5 mm aluminium
  - Isolation material = 10mm styropor
  - 0.15(?) % X<sub>0</sub>
- x Tubes required on beam-pipe
  - ?



- 
- Overview
  - Mechanics
  - Cooling
  - **Cabling**
  - Material budget
-



## ● Basic option

- x Flat kapton cables running from each ladder to the beam pipe
- x Small patch panel on the cryostat to interconnect to other flat kapton cables running to the next larger patch pannel some meters away
- x 2 such cables for each ladder
  - ~200 cables divided on the 2 end-caps
- x Kapton cable ~ 50  $\mu\text{m}$  thick, ~1cm wide
- x After some distance (meters) conversion to long distance cables
  - How much ?
  - What kind ?